

250mW, High Speed Switching Array

FEATURES

- Fast switching speed
- High reverse breakdown voltage rating
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant

APPLICATIONS

• For general purpose switching application

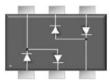
KEY PARAMETERS			
PARAMETER	VALUE	UNIT	
P _D	250	mW	
V _{RRM}	85	V	
I _F	200	mA	
V _F at I _F =150mA	1.25	V	
T _{J MAX}	150	°C	
Package	SOT-363		
Configuration	Array		

MECHANICAL DATA

- Case: SOT-363
- Molding compound meets UL 94 V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 1A whisker test
- Weight: 8 mg (approximately)







ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)				
PARAMETER		SYMBOL	VALUE	UNIT
Marking code on the device			K1	
Power dissipation		P _D	250	mW
Repetitive peak reverse voltage		V _{RRM}	85	V
Repetitive peak forward current		I _{FRM}	450	mA
Mean Forward current		I _F	200	mA
Non-Repetitive peak	t = 1 μs		4.5	A
forward surge current	t = 1 s	IFSM	0.5	
Junction temperature range		TJ	-55 to +150	°C
Storage temperature range		T _{STG}	-55 to +150	°C



Taiwan Semiconductor

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS SYMBOL		MIN	MAX	UNIT
	I _F = 1mA			0.715	
	I _F = 10mA		-	0.855	V
Forward voltage per diode ⁽¹⁾	I _F = 50mA	V _F		1.000	
	I _F = 100mA			1.200	
	I _F = 150mA			1.250	
Reverse voltage	I _R = 2.5 μA	V _R	75	-	V
Reverse current @ rated V_R	V _R = 75 V		_	1	
per diode	v _R = 75 v	I _R		ľ	μA
Junction capacitance	1 MHz, V _R =0V	CJ	-	1.5	pF
Reverse recovery time	Reverse recovery time $I_F = I_R = 10 \text{ mA}$, $R_L = 100 \Omega$		-	4	ns

Notes:

1. Pulse test with PW=0.3 ms

ORDERING INFORMATION			
ORDERING CODE	PACKAGE	PACKING	
BAV99S RFG	SOT-363	3K / 7" Reel	
BAV99S RF	SOT-363	3K / 7" Reel	

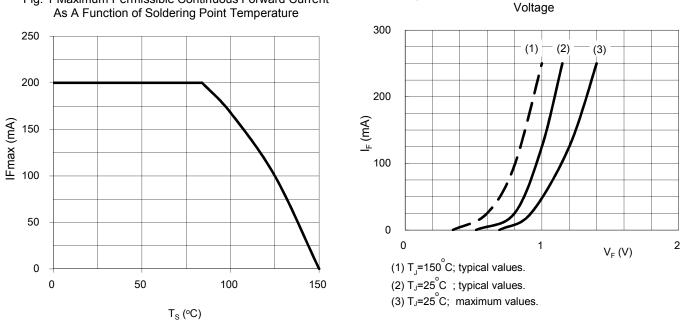
Note: "G" means green compound (halogen free)

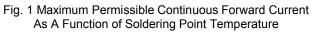


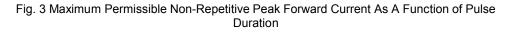
Fig. 2 Forward Current As A Function of Forward

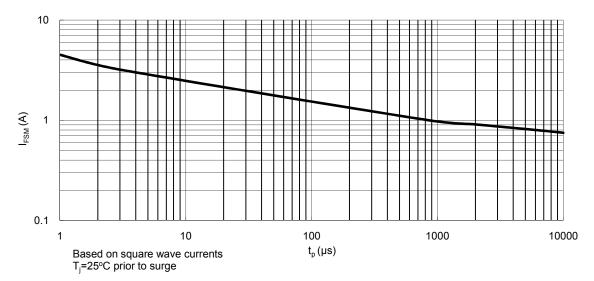
CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)





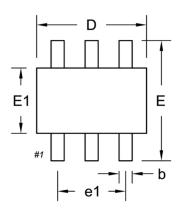


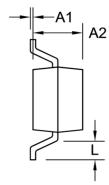




PACKAGE OUTLINE DIMENSION

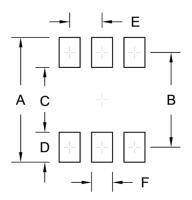
SOT-363





DIM.	Unit (mm)		Unit ((inch)	
Divi.	Min.	Max.	Min.	Max.	
A1	0.00	0.10	0.000	0.004	
A2	0.85	1.05	0.033	0.041	
b	0.15	0.35	0.006	0.014	
D	2.00	2.20	0.079	0.087	
Е	2.15	2.45	0.085	0.096	
E1	1.15	1.35	0.045	0.053	
e1	1.20	1.40	0.047	0.055	
L	0.25	0.46	0.010	0.018	

SUGGEST PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
A	2.50	0.098
В	1.90	0.075
С	1.30	0.051
D	0.60	0.024
E	0.65	0.026
F	0.42	0.017



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